HALOGEN FREE



Vishay General Semiconductor

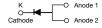
SMD Photovoltaic Solar Cell Protection Trench MOS Barrier Schottky Rectifiers

Ultra Low $V_F = 0.31 \text{ V}$ at $I_F = 5 \text{ A}$

TMBS® eSMP® Series



TO-277A (SMPC)



PRIMARY CHARACTERISTICS			
I _{F(AV)}	15 A		
V _{RRM}	45 V		
I _{FSM}	210 A		
V _F at I _F = 15 A	0.42 V		
T _J max.	150 °C		
Package	TO-277A (SMPC)		
Diode variation	Single die		

FEATURES

- Very low profile typical height of 1.1 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

PARAMETER	SYMBOL	V15P45S	UNIT	
Device marking code		1545S		
Maximum repetitive peak reverse voltage	V _{RRM}	45	V	
Maximum DC forward current	I _F ⁽¹⁾	15		
	I _F ⁽²⁾	4.8	_ A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	210	А	
Junction temperature in DC forward current without reverse bias, t ≤ 1 h	T _J ⁽³⁾	≤ 200	°C	
Operating junction temperature range	T _{OP}	-40 to +150	°C	
Storage temperature range	T _{STG}	-40 to +175	°C	

Notes

- (1) Mounted on 30 mm x 30 mm aluminum PCB
- (2) Free air, mounted on recommended copper pad area
- (3) Meets the requirements of IEC 61215 ed. 2 bypass diode thermal test



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 5.0 A$	T _A = 25 °C	T _A = 25 °C V _F ⁽¹⁾	0.40	-	V	
	$I_F = 7.5 A$			0.45	-		
	I _F = 15 A			0.49	0.58		
	I _F = 5.0 A	T _A = 125 °C		0.31	-		
	I _F = 7.5 A		T _A = 125 °C	T _A = 125 °C	0.34	-	
	I _F = 15 A			0.42	0.51		
Reverse current	V _R = 45 V	T _A = 25 °C	/ [_ (2) [-	1500	μA	
	v _R = 45 v	T _A = 125 °C	IR (=)	15	50	mA	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V15P45S	UNIT	
Tunical thermal registence	R _{0JA} (1)	75	°C/W	
Typical thermal resistance	R _{0JM} (2)	4		

Notes

- (1) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- (2) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance R_{0,IM} junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V15P45S-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V15P45S-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

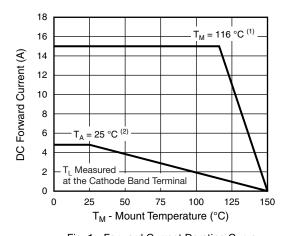


Fig. 1 - Forward Current Derating Curve

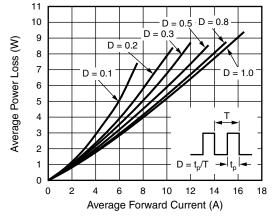


Fig. 2 - Forward Power Loss Characteristics Per Diode

Notes

 $^{(1)}$ Mounted on 30 mm x 30 mm aluminum PCB; T_M measured at the terminal of cathode band $(R_{\theta JM}$ = 4 °C/W)

 $^{(2)}$ Free air, mounted on recommended copper pad area $(R_{\theta JA} = 75~^{\circ}\text{C/W})$



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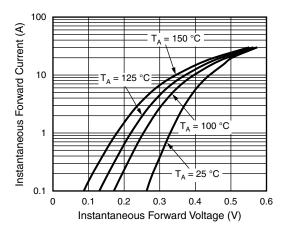


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

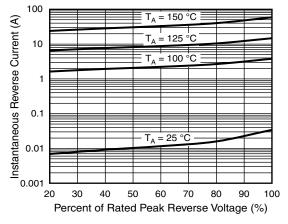


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

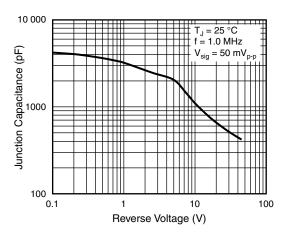


Fig. 5 - Typical Junction Capacitance

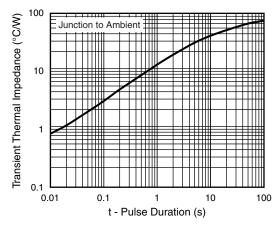
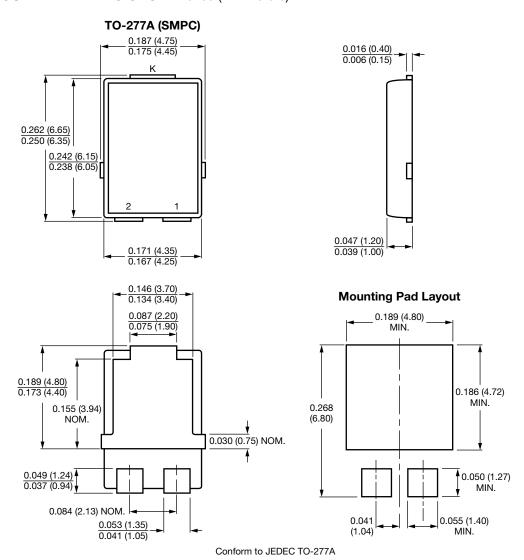


Fig. 6 - Typical Transient Thermal Impedance Per Diode



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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